

**General Description**

- Very fast and soft recovery freewheeling diode
- High efficient turn-on di/dt controllability
- Low  $V_{CE(sat)}$  for low conduction losses
- Soft switching performance and low EMI
- High electrostatic performance
- High short-circuit ruggedness

**Applications**

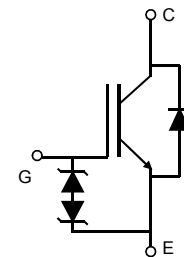
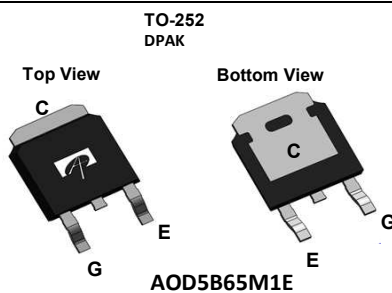
- Low power motor drives
- Home appliances such as refrigerators and washing machines
- Fan motors, pumps, and vacuum cleaners

**Product Summary**

$V_{CE}$	650V
$I_C$ ( $T_C=100^\circ\text{C}$ )	5A
$V_{CE(sat)}$ ( $T_J=25^\circ\text{C}$ )	2.15V

Typical ESD protection

HBM Class 2



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOD5B65M1E	TO252	Tape & Reel	2500

**Absolute Maximum Ratings  $T_A=25^\circ\text{C}$  unless otherwise noted**

Parameter	Symbol	AOD5B65M1E	Units
Collector-Emitter Voltage	$V_{CE}$	650	V
Gate-Emitter Voltage	$V_{GE}$	$\pm 20$	V
Continuous Collector Current	$I_C$	$T_C=25^\circ\text{C}$	10
		$T_C=100^\circ\text{C}$	5
Pulsed Collector Current, Limited by $T_{Jmax}$	$I_{CM}$	15	A
Turn-Off SOA, $V_{CE} \leq 650\text{V}$ , Limited by $T_{Jmax}$	$I_{LM}$	15	A
Continuous Diode Forward Current	$I_F$	$T_C=25^\circ\text{C}$	10
		$T_C=100^\circ\text{C}$	5
Diode Pulsed Current, Limited by $T_{Jmax}$	$I_{FM}$	15	A
Short Circuit Withstanding Time <sup>(1)</sup> $V_{GE}=15\text{V}$ , $V_{CC} \leq 400\text{V}$ , $T_J \leq 150^\circ\text{C}$	$t_{SC}$	5	$\mu\text{s}$
Power Dissipation	$P_D$	$T_C=25^\circ\text{C}$	52
		$T_C=100^\circ\text{C}$	21
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	$^\circ\text{C}$
Maximum Lead Temperature for Soldering Purpose, 1/8" from case for 5 seconds	$T_L$	300	$^\circ\text{C}$

**Thermal Characteristics**

Parameter	Symbol	AOD5B65M1E	Units
Maximum Junction-to-Ambient	$R_{\theta JA}$	55	$^\circ\text{C/W}$
Maximum IGBT Junction-to-Case	$R_{\theta JC}$	2.4	$^\circ\text{C/W}$
Maximum Diode Junction-to-Case	$R_{\theta JC}$	5.5	$^\circ\text{C/W}$

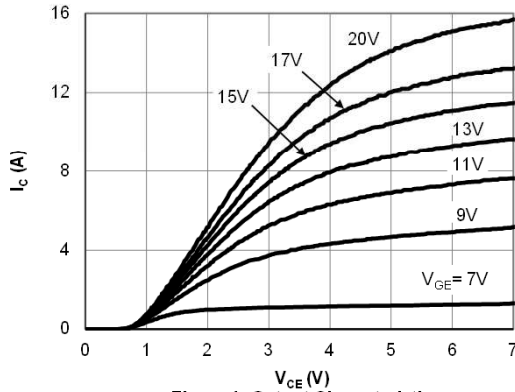
(1) Allowed number of short circuits: &lt;1000; time between short circuits: &gt;1s.

**Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

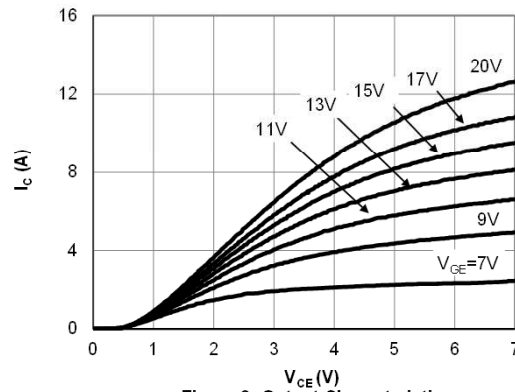
Symbol	Parameter	Conditions	Min	Typ	Max	Units	
<b>STATIC PARAMETERS</b>							
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> =1mA, V <sub>GE</sub> =0V, T <sub>J</sub> =25°C	650	-	-	V	
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	V <sub>GE</sub> =15V, I <sub>C</sub> =5A	T <sub>J</sub> =25°C	-	2.15	2.7	V
			T <sub>J</sub> =125°C	-	2.74	-	
			T <sub>J</sub> =150°C	-	2.89	-	
V <sub>F</sub>	Diode Forward Voltage	V <sub>GE</sub> =0V, I <sub>F</sub> =5A	T <sub>J</sub> =25°C	-	1.9	2.25	V
			T <sub>J</sub> =125°C	-	2.05	-	
			T <sub>J</sub> =150°C	-	2.01	-	
V <sub>GE(th)</sub>	Gate-Emitter Threshold Voltage	V <sub>CE</sub> =5V, I <sub>C</sub> =1mA	-	5.1	-	V	
I <sub>CES</sub>	Zero Gate Voltage Collector Current	V <sub>CE</sub> =650V, V <sub>GE</sub> =0V	T <sub>J</sub> =25°C	-	-	10	μA
			T <sub>J</sub> =125°C	-	-	100	
			T <sub>J</sub> =150°C	-	-	500	
I <sub>GES</sub>	Gate-Emitter Leakage Current	V <sub>CE</sub> =0V, V <sub>GE</sub> =±20V	-	-	±10	μA	
g <sub>FS</sub>	Forward Transconductance	V <sub>CE</sub> =20V, I <sub>C</sub> =5A	-	2	-	S	
<b>DYNAMIC PARAMETERS</b>							
C <sub>ies</sub>	Input Capacitance	V <sub>GE</sub> =0V, V <sub>CC</sub> =25V, f=1MHz	-	235	-	pF	
C <sub>oes</sub>	Output Capacitance		-	28	-	pF	
C <sub>res</sub>	Reverse Transfer Capacitance		-	5	-	pF	
Q <sub>g</sub>	Total Gate Charge	V <sub>GE</sub> =15V, V <sub>CC</sub> =520V, I <sub>C</sub> =5A	-	8.8	-	nC	
Q <sub>ge</sub>	Gate to Emitter Charge		-	2.6	-	nC	
Q <sub>gc</sub>	Gate to Collector Charge		-	3.4	-	nC	
I <sub>C(SC)</sub>	Short Circuit Collector Current	V <sub>GE</sub> =15V, V <sub>CC</sub> =400V, t <sub>sc</sub> ≤5us, T <sub>J</sub> ≤150°C	-	20	-	A	
R <sub>g</sub>	Gate Resistance	V <sub>GE</sub> =0V, V <sub>CC</sub> =0V, f=1MHz	-	20	-	Ω	
<b>SWITCHING PARAMETERS, (Load Inductive, T<sub>J</sub>=25°C)</b>							
t <sub>D(on)</sub>	Turn-On Delay Time	T <sub>J</sub> =25°C V <sub>GE</sub> =15V, V <sub>CC</sub> =400V, I <sub>C</sub> =5A, R <sub>G</sub> =60Ω	-	7	-	ns	
t <sub>r</sub>	Turn-On Rise Time		-	13	-	ns	
t <sub>D(off)</sub>	Turn-Off Delay Time		-	78	-	ns	
t <sub>f</sub>	Turn-Off Fall Time		-	20	-	ns	
E <sub>on</sub>	Turn-On Energy		-	0.09	-	mJ	
E <sub>off</sub>	Turn-Off Energy		-	0.06	-	mJ	
E <sub>total</sub>	Total Switching Energy		-	0.15	-	mJ	
t <sub>rr</sub>	Diode Reverse Recovery Time		T <sub>J</sub> =25°C	-	172	-	ns
Q <sub>rr</sub>	Diode Reverse Recovery Charge		I <sub>F</sub> =5A, di/dt=200A/μs, V <sub>CC</sub> =400V	-	0.19	-	μC
I <sub>rm</sub>	Diode Peak Reverse Recovery Current	-	-	2.57	-	A	
<b>SWITCHING PARAMETERS, (Load Inductive, T<sub>J</sub>=150°C)</b>							
t <sub>D(on)</sub>	Turn-On Delay Time	T <sub>J</sub> =150°C V <sub>GE</sub> =15V, V <sub>CC</sub> =400V, I <sub>C</sub> =5A, R <sub>G</sub> =60Ω	-	6.5	-	ns	
t <sub>r</sub>	Turn-On Rise Time		-	14	-	ns	
t <sub>D(off)</sub>	Turn-Off Delay Time		-	96	-	ns	
t <sub>f</sub>	Turn-Off Fall Time		-	34	-	ns	
E <sub>on</sub>	Turn-On Energy		-	0.10	-	mJ	
E <sub>off</sub>	Turn-Off Energy		-	0.10	-	mJ	
E <sub>total</sub>	Total Switching Energy		-	0.20	-	mJ	
t <sub>rr</sub>	Diode Reverse Recovery Time		T <sub>J</sub> =150°C	-	257	-	ns
Q <sub>rr</sub>	Diode Reverse Recovery Charge		I <sub>F</sub> =5A, di/dt=200A/μs, V <sub>CC</sub> =400V	-	0.32	-	μC
I <sub>rm</sub>	Diode Peak Reverse Recovery Current	-	-	3.19	-	A	

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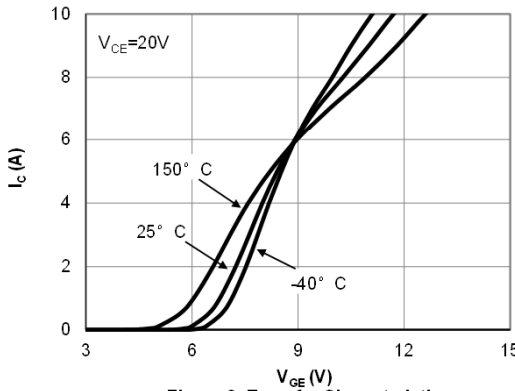
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



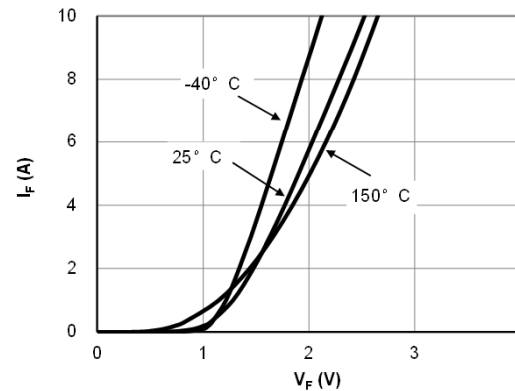
**Figure 1: Output Characteristic**  
( $T_j=25^\circ\text{C}$ )



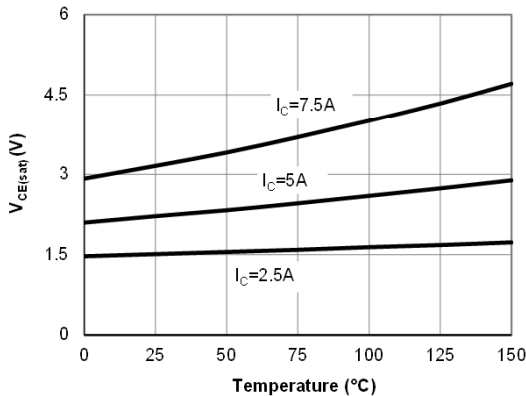
**Figure 2: Output Characteristic**  
( $T_j=150^\circ\text{C}$ )



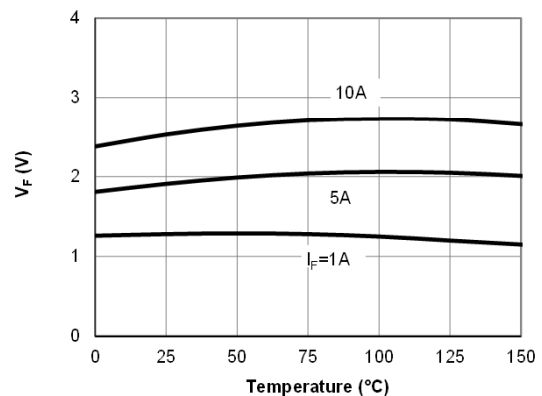
**Figure 3: Transfer Characteristic**



**Figure 4: Diode Characteristic**

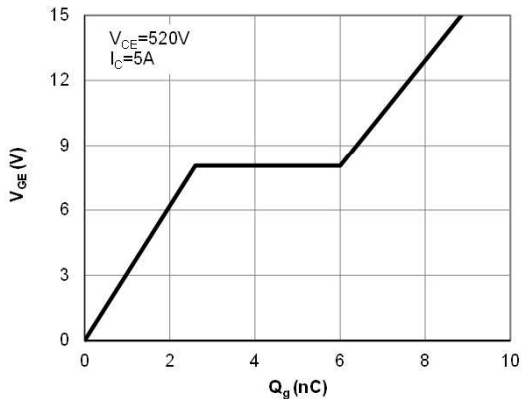


**Figure 5: Collector-Emitter Saturation Voltage vs. Junction Temperature**

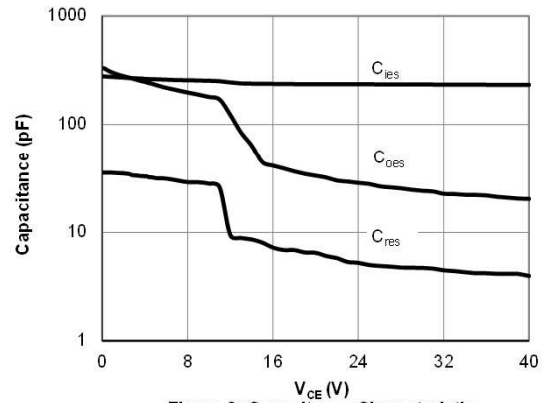


**Figure 6: Diode Forward voltage vs. Junction Temperature**

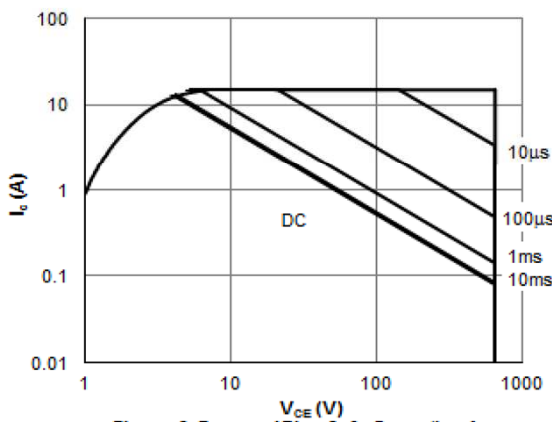
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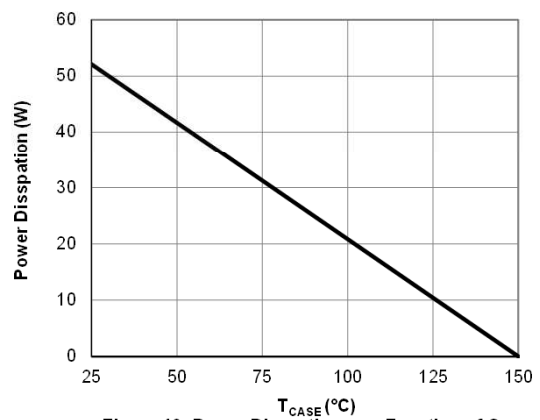
**Figure 7: Gate-Charge Characteristics**



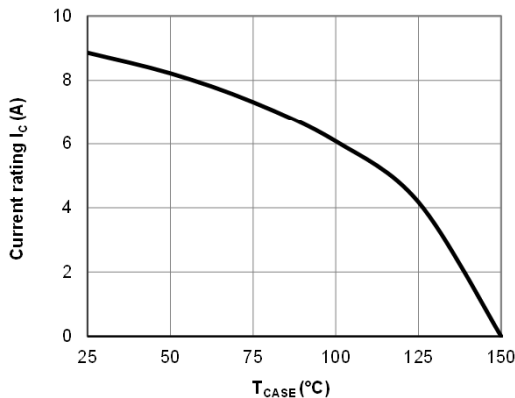
**Figure 8: Capacitance Characteristic**



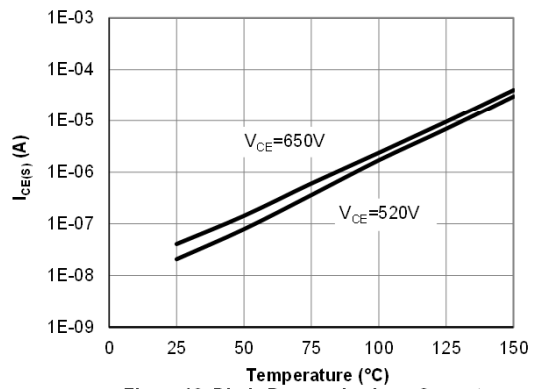
**Figure 9: Forward Bias Safe Operating Area**  
( $T_C=25^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ )



**Figure 10: Power Dissipation as a Function of Case**

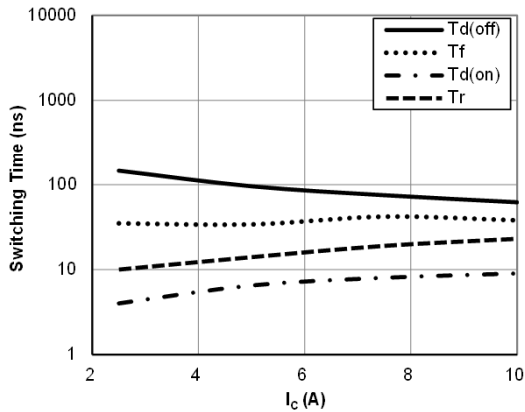


**Figure 11: Current De-rating**

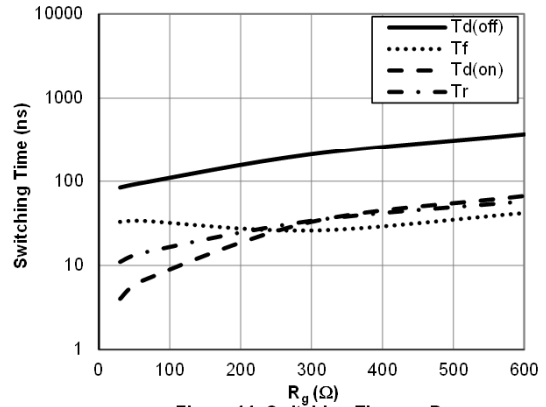


**Figure 12: Diode Reverse Leakage Current vs. Junction Temperature**

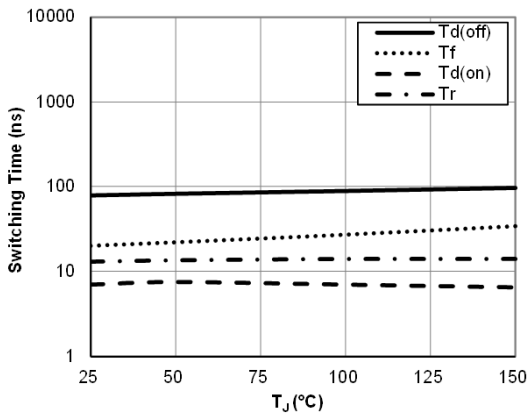
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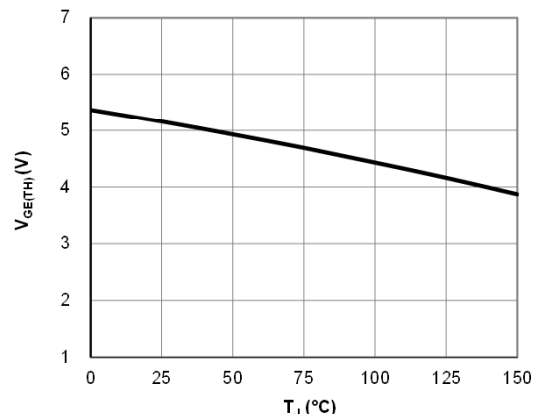
**Figure 13: Switching Time vs.  $I_C$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $R_g=60\Omega$ )



**Figure 14: Switching Time vs.  $R_g$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=5\text{A}$ )

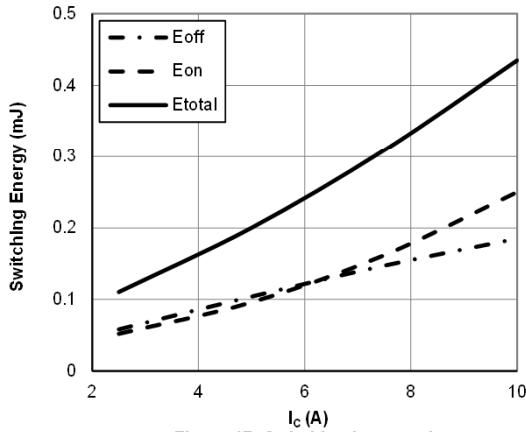


**Figure 15: Switching Time vs.  $T_J$**   
( $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=5\text{A}$ ,  $R_g=60\Omega$ )

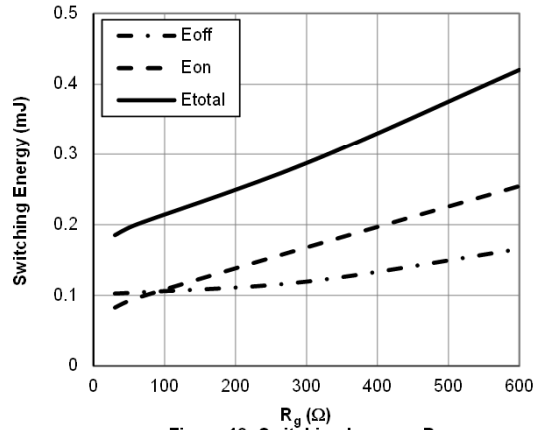


**Figure 16:  $V_{GE(TH)}$  vs.  $T_J$**

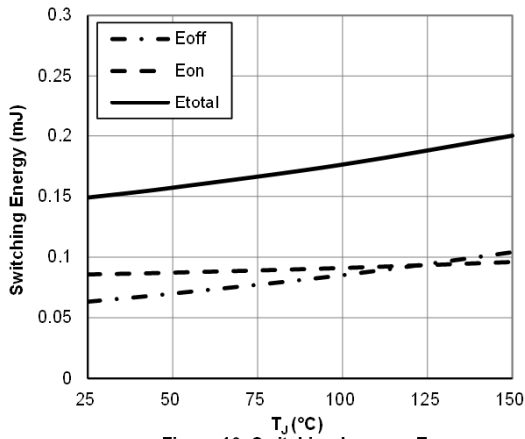
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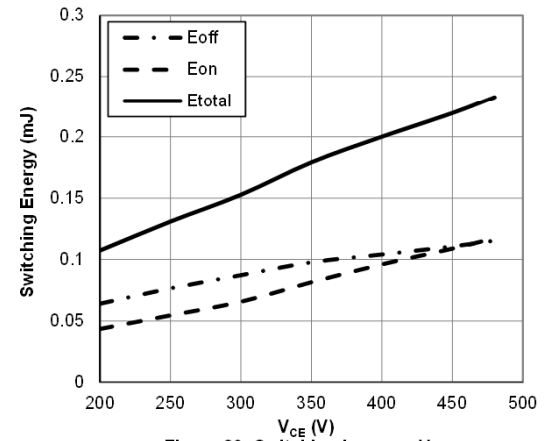
**Figure 17: Switching Loss vs.  $I_C$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $R_g=60\Omega$ )



**Figure 18: Switching Loss vs.  $R_g$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=5\text{A}$ )

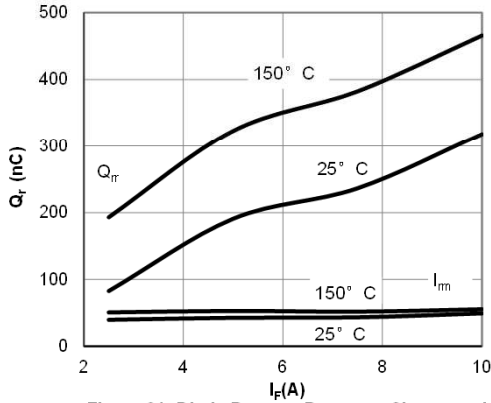


**Figure 19: Switching Loss vs.  $T_J$**   
( $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=5\text{A}$ ,  $R_g=60\Omega$ )

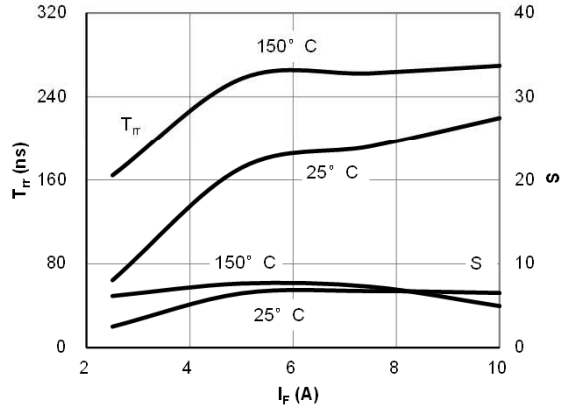


**Figure 20: Switching Loss vs.  $V_{CE}$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $I_C=5\text{A}$ ,  $R_g=60\Omega$ )

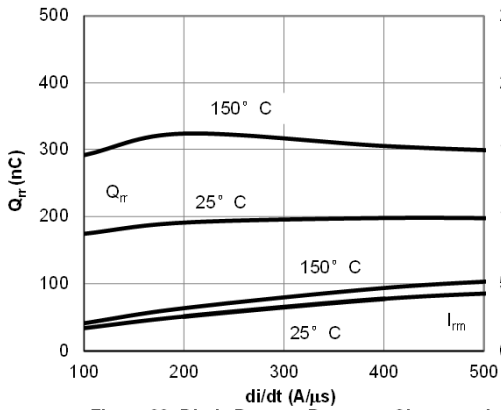
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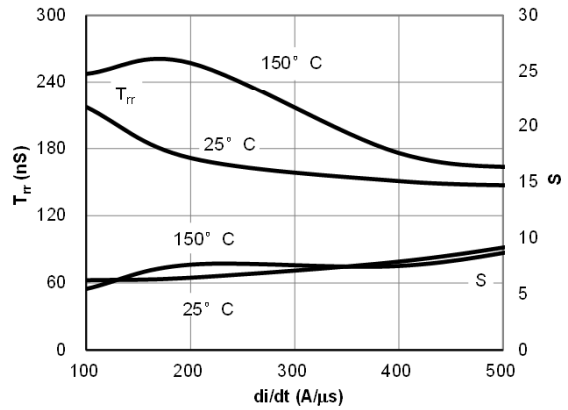
**Figure 21: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $di/dt=200A/\mu s$ )



**Figure 22: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $di/dt=200A/\mu s$ )

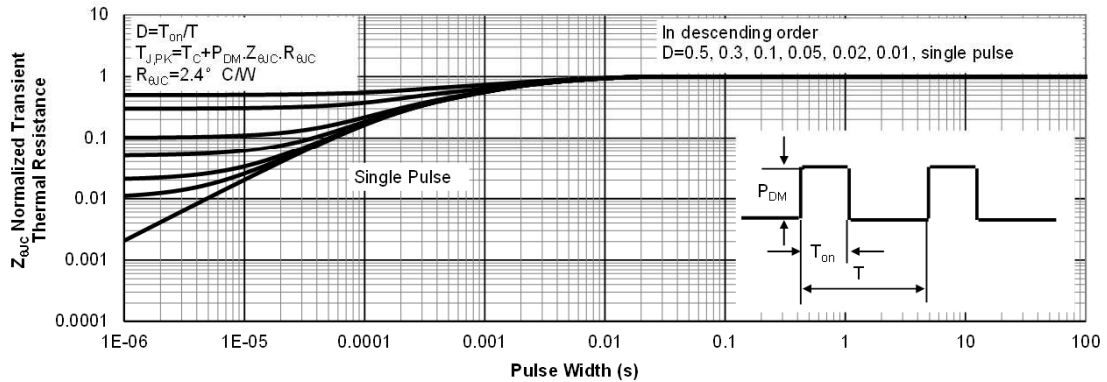


**Figure 23: Diode Reverse Recovery Charge and Peak Current vs. di/dt**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $I_F=5A$ )

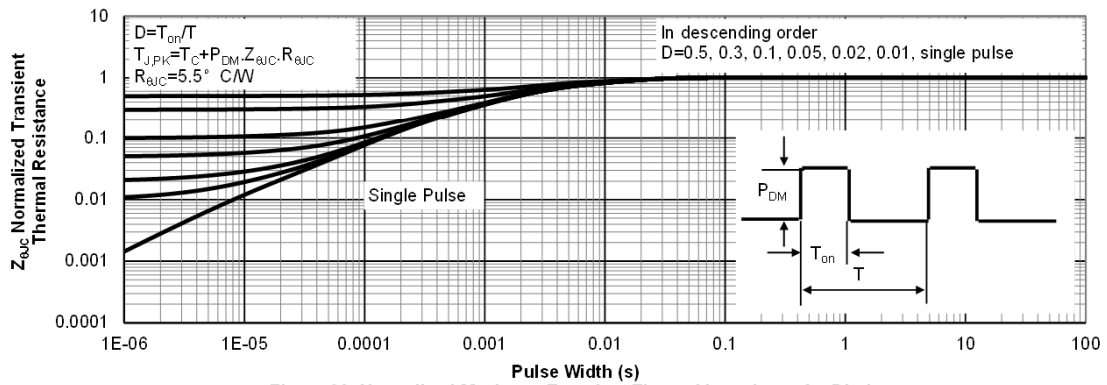


**Figure 24: Diode Reverse Recovery Time and Softness Factor vs. di/dt**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $I_F=5A$ )

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



**Figure 25: Normalized Maximum Transient Thermal Impedance for IGBT**



**Figure 26: Normalized Maximum Transient Thermal Impedance for Diode**

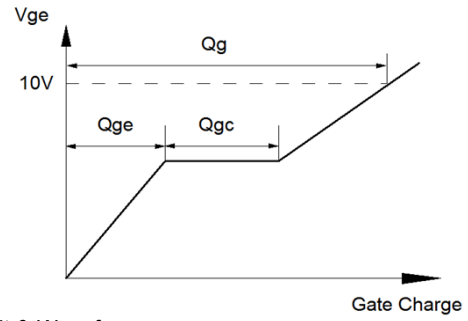
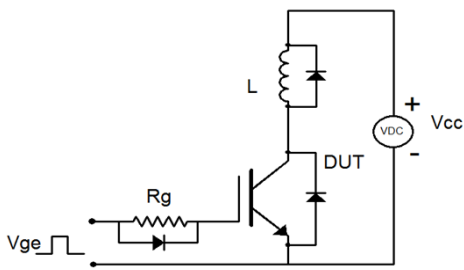


Figure A: Gate Charge Test Circuit & Waveforms

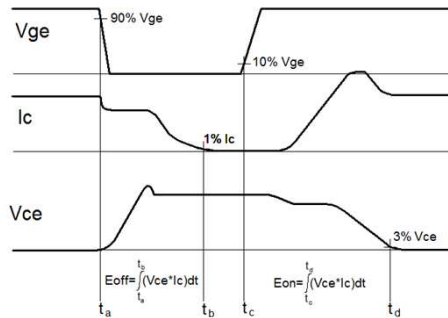
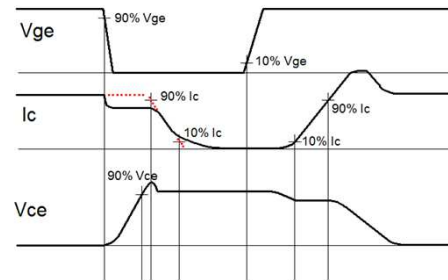
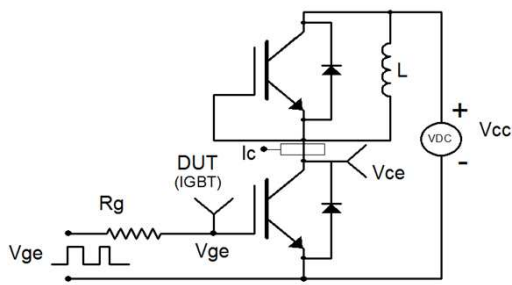


Figure B: Inductive Switching Test Circuit & Waveforms

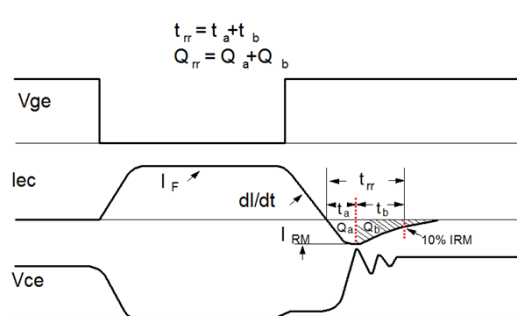
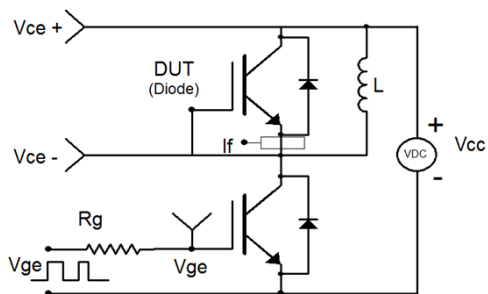


Figure C: Diode Recovery Test Circuit & Waveforms